

# **FMV19N60E**

**FUJI POWER MOSFET** 

## Super FAP-E<sup>3</sup> series

## **N-CHANNEL SILICON POWER MOSFET**

#### ■ Features

Maintains both low power loss and low noise Lower R<sub>DS</sub>(on) characteristic More controllable switching dv/dt by gate resistance Smaller V<sub>GS</sub> ringing waveform during switching Narrow band of the gate threshold voltage (3.0±0.5V) High avalanche durability

## Applications

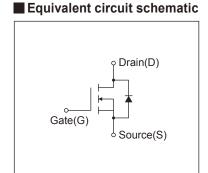
Switching regulators UPS (Uninterruptible Power Supply) DC-DC converters

## Maximum Ratings and Characteristics

## ● Absolute Maximum Ratings at Tc=25°C (unless otherwise specified)

TO-220F(SLS)  100.180  100.85	2,7 m.2 2,7 m.2 2,7 m.2 2,7 m.2 0.5 § <sup>3</sup> 2,7 m.2 0 mection 0 pair 0 pair 0 surce
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■ Outline Drawings [mm]



Description	Symbol	Characteristics	Unit	Remarks
Dunius Courses Voltages	V <sub>DS</sub>	600	V	
Drain-Source Voltage	V <sub>DSX</sub>	600	V	V <sub>GS</sub> = -30V
Continuous Drain Current	ID	±19	Α	
Pulsed Drain Current	IDP	±76	Α	
Gate-Source Voltage	V <sub>GS</sub>	±30	V	
Repetitive and Non-Repetitive Maximum Avalanche Current	Iar	19	Α	Note*1
Non-Repetitive Maximum Avalanche Energy	Eas	799	mJ	Note*2
Repetitive Maximum Avalanche Energy	Ear	13	mJ	Note*3
Peak Diode Recovery dV/dt	dV/dt	6.5	kV/µs	Note*4
Peak Diode Recovery -di/dt	-di/dt	100	A/µs	Note*5
Martin and Province Control		2.16	144	Ta=25°C
Maximum Power Dissipation	P□	130	W	Tc=25°C
O	Tch	150	°C	
Operating and Storage Temperature range	T <sub>stg</sub>	-55 to + 150	°C	
Isolation Voltage	Viso	2	kVrms	t = 60sec, f = 60H

#### ● Electrical Characteristics at Tc=25°C (unless otherwise specified)

Description	Symbol	Conditions		min.	typ.	max.	Unit	
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	I <sub>D</sub> =250μA, V <sub>GS</sub> =0V		600	-	-	V	
Gate Threshold Voltage	V <sub>GS</sub> (th)	In=250µA, Vns=Vgs	I <sub>D</sub> =250μA, V <sub>DS</sub> =V <sub>GS</sub>		3.0	3.5	V	
Zero Gate Voltage Drain Current		V <sub>DS</sub> =600V, V <sub>GS</sub> =0V	T <sub>ch</sub> =25°C	-	-	25		
	IDSS	V <sub>DS</sub> =480V, V <sub>GS</sub> =0V	T <sub>ch</sub> =125°C	-	-	250	μA	
Gate-Source Leakage Current	Igss	V <sub>GS</sub> =±30V, V <sub>DS</sub> =0V	V <sub>GS</sub> =±30V, V <sub>DS</sub> =0V		10	100	nA	
Drain-Source On-State Resistance	R <sub>DS</sub> (on)	I <sub>D</sub> =9.5A, V <sub>GS</sub> =10V		-	0.31	0.365	Ω	
Forward Transconductance	g <sub>fs</sub>	I <sub>D</sub> =9.5A, V <sub>DS</sub> =25V		13	26	-	S	
Input Capacitance	Ciss	V <sub>DS</sub> =25V		-	3600	5400		
Output Capacitance	Coss	V <sub>GS</sub> =0V		-	310	465	pF	
Reverse Transfer Capacitance	Crss	f=1MHz		-	23	35	1	
Turn-On Time Turn-Off Time	td(on)	V <sub>cc</sub> =300V V <sub>ds</sub> =10V I <sub>D</sub> =9.5A R <sub>ds</sub> =8.2Ω		-	26	39	ns	
	tr			-	13	20		
	td(off)			-	150	225		
	tf			-	20	30		
Total Gate Charge	QG	Vcc=300V	Vcc=300V In=19A		105	160	nC	
Gate-Source Charge	Qgs	ID=19A			23	35		
Gate-Drain Charge	Q <sub>GD</sub>	V <sub>GS</sub> =10V		-	30	45		
Avalanche Capability	lav	L=1.71mH, Tch=25°C	L=1.71mH, Tch=25°C		-	-	Α	
Diode Forward On-Voltage	V <sub>SD</sub>	I <sub>F</sub> =19A, V <sub>GS</sub> =0V, T <sub>ch</sub> =25°	I <sub>F</sub> =19A, V <sub>GS</sub> =0V, T <sub>ch</sub> =25°C		0.90	1.35	V	
Reverse Recovery Time	trr	I <sub>F</sub> =19A, V <sub>GS</sub> =0V	I <sub>F</sub> =19A, V <sub>GS</sub> =0V		0.6	-	μs	
Reverse Recovery Charge	Qrr	-di/dt=100A/µs, Tch=25°C		-	10	-	μC	

#### Thermal Characteristics

Description	tion Symbol Test Conditions		min.	typ.	max.	Unit
Thermal resistance	Rth (ch-c)	Channel to case			0.96	°C/W
	Rth (ch-a)	Channel to ambient			58.0	°C/W

Note \*1 : Tch≤150°C

Note \*2: Stating Tch=25°C, Ias=8A, L=22.9mH, Vcc=60V, R<sub>G</sub>=50Ω

Eas limited by maximum channel temperature and avalanche current.

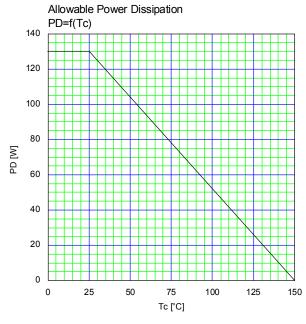
See to 'Avalanche Energy' graph.

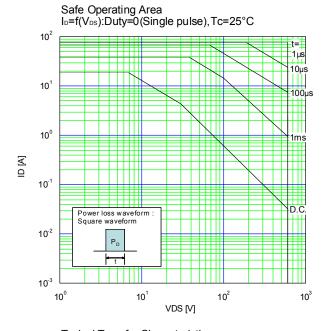
Note \*3 : Repetitive rating : Pulse width limited by maximum channel temperature. See to the 'Transient Themal impeadance' graph.

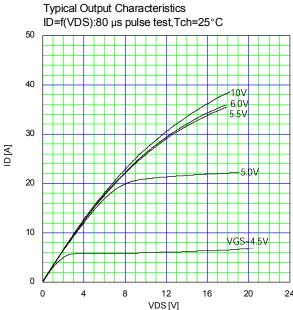
Note \*4 : Ir≤-I₀, -di/dt=100A/μs, Vcc≤BVɒss, Tch≤150°C.

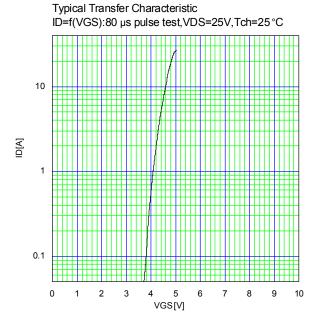
Note \*5 : Ir≤-I₀, dv/dt=5.0kV/μs, Vcc≤BVɒss, Tch≤150°C.

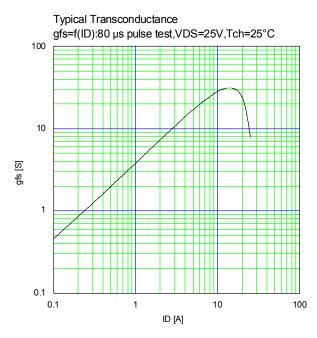
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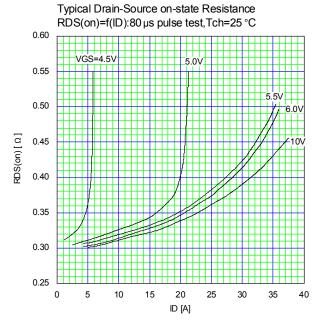


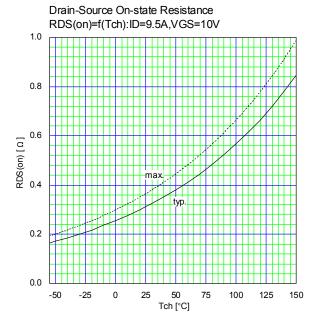


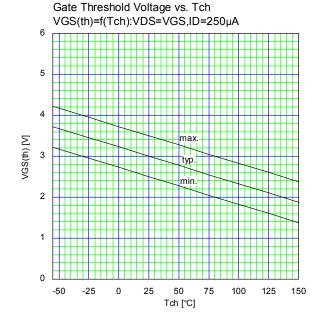


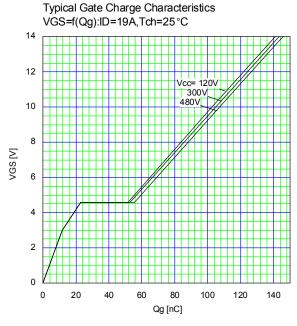


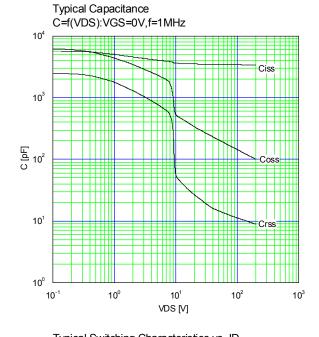


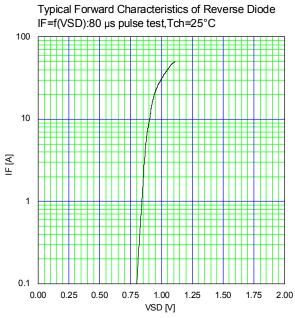


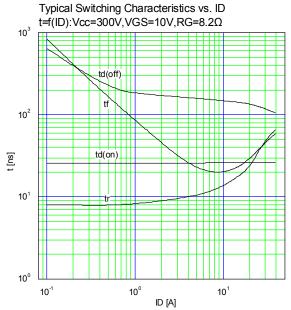


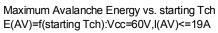


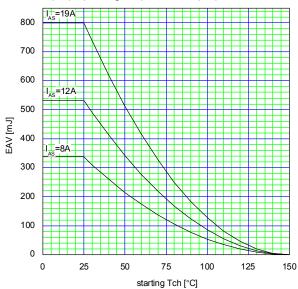


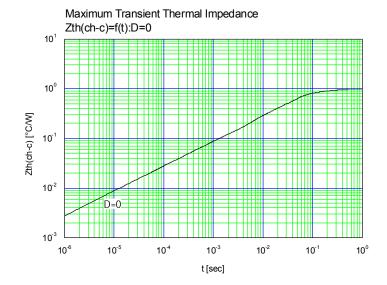












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